# **Panasonic**

Zener Diode DZ2S200×0L

## DZ2S200×0L Silicon epitaxial planar type

### For constant voltage / For surge absorption circuit DZ2J200 in SSMini2 type package

#### Features

- Excellent rising characteristics of zener current Iz ٠
- · Low zener operating resistance Rz
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)
- Marking Symbol: ZJ or ZU

#### Packaging

Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)

■ Absolute Maximum Ratings Ta = 25 °C							
Parameter	Symbol	Rating	Unit				
Repetitive peak forward current	IFRM	200	mA				
Total power dissipation *1	PT	150	mW				
Electrostatic discharge <sup>*2</sup>	ESD	±8	kV				
Junction temperature	Tj	150	°C				
Operating ambient temperature	Topr	-40 to +85	°C				
Storage temperature	Tstg	-55 to +150	°C				

-55 to +150 Note) \*1 Mounted on glass epoxy print board (  $45~\text{mm}\times45~\text{mm}\times1~\text{mm}$  ) Solder in ( $0.8 \text{ mm} \times 0.6 \text{ mm}$ )

\*2 Test method : IEC61000\_4\_2

(C = 150 pF, R = 330 Ω, Contact discharge : 10 times )



\*3 Tj = 25 °C to 150 °C

Electrical Characteristics $Ta = 25 °C$	±3°C					
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	VF	IF = 10 mA			1.0	V
Zener voltage *1, *2	VZ	IZ = 5 mA	19.00		21.00	V
Zener operating resistance	RZ	IZ = 5 mA			80	Ω
Zener rise operating resistance	RZK	IZ = 0.5 mA			100	Ω
Reverse current	IR	VR = 15 V			0.05	μA
Temperature coefficient of zener voltage *3	SZ	IZ = 5 mA		18.4		mV/°C

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.

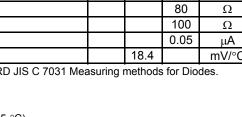
2. Absolute frequency of input and output is 5 MHz.

3. \*1 The temperature must be controlled 25 °C for VZ mesurement.

VZ value measured at other temperature must be adjusted to VZ (25 °C).

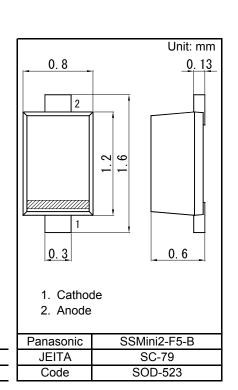
\*2 VZ guaranted 20 ms after current flow Rank classification

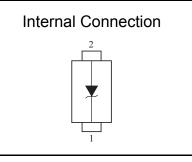
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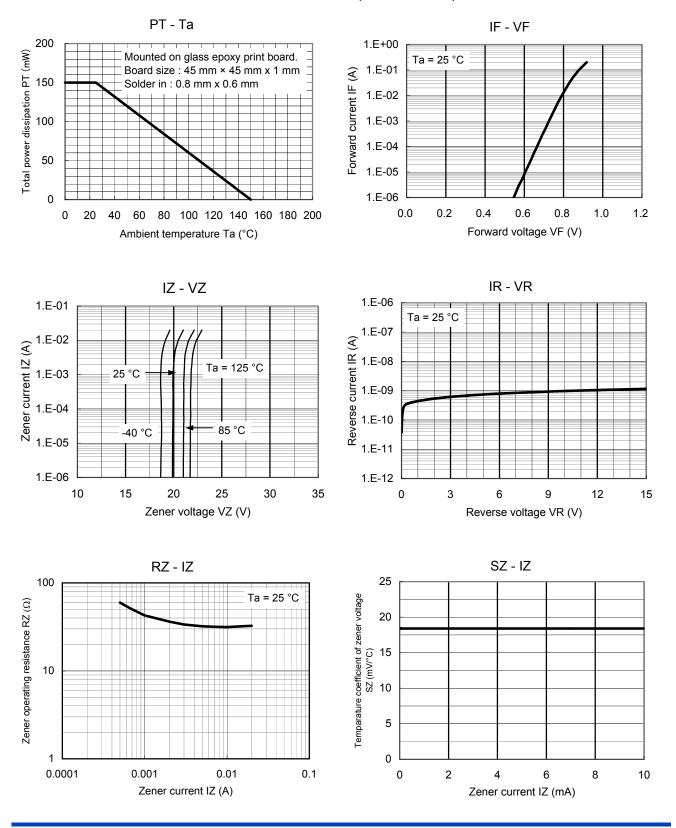






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## Technical Data (reference)

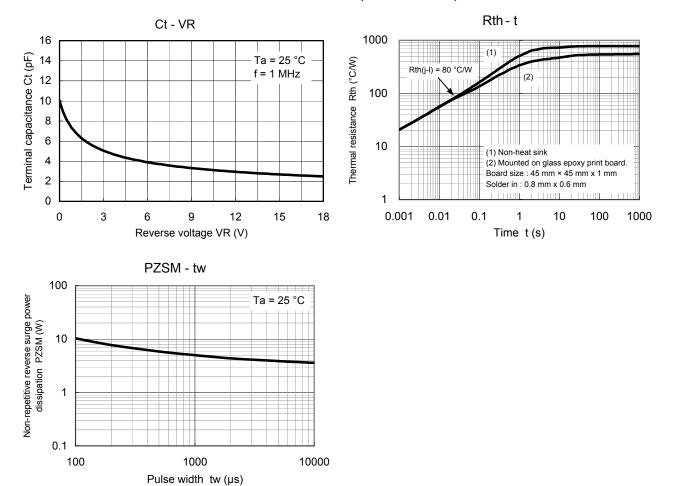


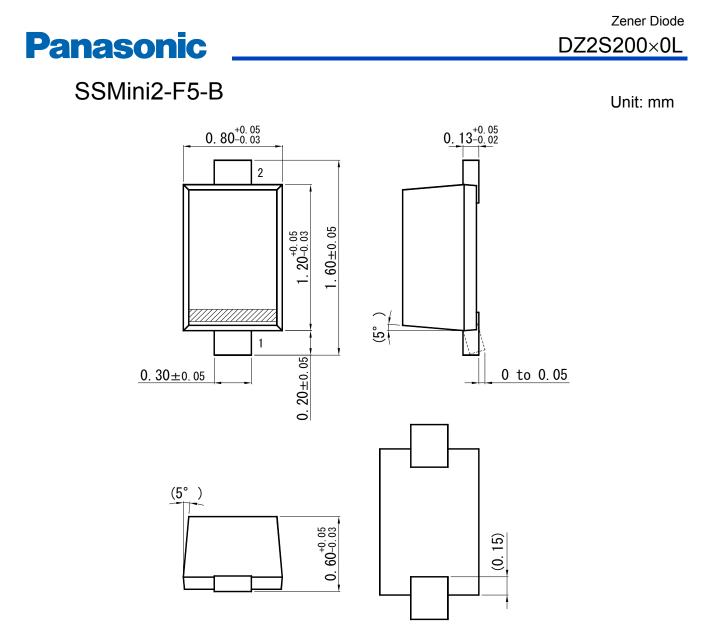




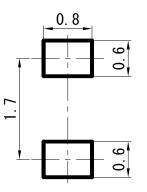
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■ Land Pattern (Reference) (Unit: mm)



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